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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/681,983	10/09/2003	Chun Ho Fan	618902001410	8846
25227	7590	01/28/2008	EXAMINER	
MORRISON & FOERSTER LLP			ANDUJAR, LEONARDO	
1650 TYSONS BOULEVARD				
SUITE 400			ART UNIT	PAPER NUMBER
MCLEAN, VA 22102			2826	
			MAIL DATE	DELIVERY MODE
			01/28/2008	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

T/1

Office Action Summary	Application No.	Applicant(s)
	10/681,983	FAN ET AL.
	Examiner	Art Unit
	Leonardo Andújar	2826

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

1) Responsive to communication(s) filed on 11/13/2007.
 2a) This action is FINAL. 2b) This action is non-final.
 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

4) Claim(s) 11-16 is/are pending in the application.
 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
 5) Claim(s) _____ is/are allowed.
 6) Claim(s) 11 and 16 is/are rejected.
 7) Claim(s) 15 and 16 is/are objected to.
 8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

9) The specification is objected to by the Examiner.
 10) The drawing(s) filed on 09 October 2003 is/are: a) accepted or b) objected to by the Examiner.
 Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
 Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
 a) All b) Some * c) None of:
 1. Certified copies of the priority documents have been received.
 2. Certified copies of the priority documents have been received in Application No. _____.
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

1) Notice of References Cited (PTO-892)
 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)
 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
 Paper No(s)/Mail Date _____.
 4) Interview Summary (PTO-413)
 Paper No(s)/Mail Date _____.
 5) Notice of Informal Patent Application (PTO-152)
 6) Other: _____

DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 10/15/2007 has been entered.

Claim Rejections - 35 USC § 103

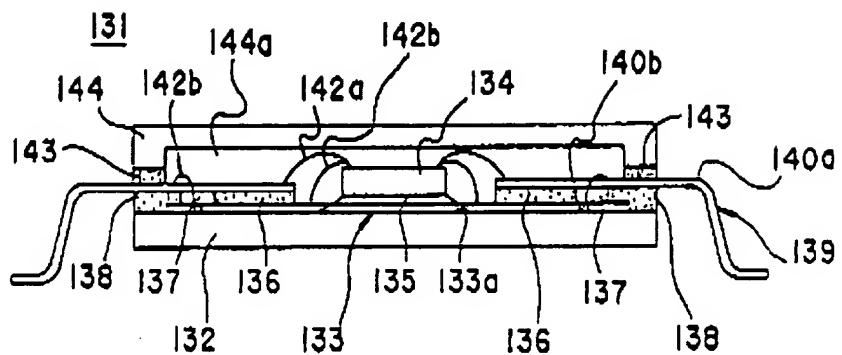
2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

3. Claim 11 is rejected under 35 U.S.C. 103(a) as being unpatentable over Tsuji (US5,804,468) in view of Morifuji (US 6,175,157).

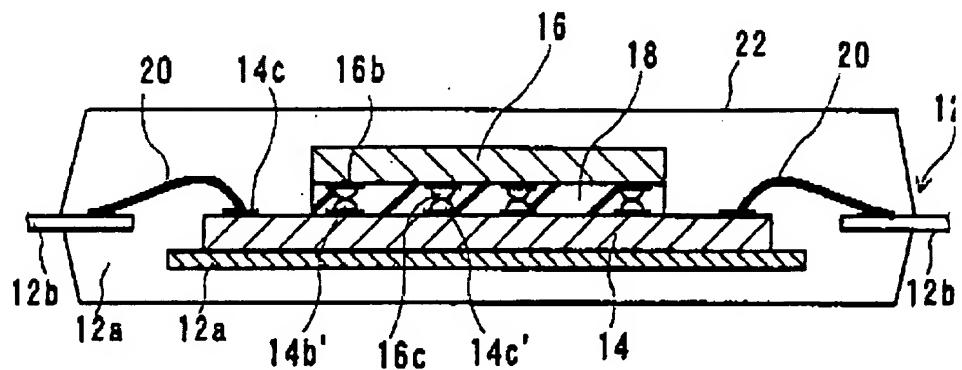
4. Regarding claim 11, Tesjui (e.g. fig. 11b) shows a integrated circuit package comprising: a first lead frame 133 having a first side and a second side, opposite the first side; a second lead frame 139 laminated to the first side of the first lead frame (e.g. top side) in order to create a multi layer lead frame; and a semiconductor die 134 mounted to another portion of the first side of the first leadframe

FIG. 11B



Tsuji does not show a plurality of contacts balls mounted on the semiconductor die. However, Morifuji (e.g. 7) shows a semiconductor device 14 having a plurality of contact balls 14b' mounted on the semiconductor die. According to Morifuji, this type of embodiment increases the integration density while preventing the semiconductor chip from warping and from being damaged (col. 1/lls. 5-44).

FIG. 7



It would have been obvious to one of ordinary skill in the art at the time the invention was made to include contact balls on the semiconductor die disclosed by Tsuji

in accordance with Morifudi's invention to increase the integration density while preventing the semiconductor chip from warping and from being damaged.

5. Claim 16 is rejected under 35 U.S.C. 103(a) as being unpatentable over Tsuji (US 5,804,468 in view of Morifudi (US 6,175,157) in view Takekawa et al. (US 4,714,952).

6. Regarding claim 16, Tsuji in view of Morifudi shows most aspects of the instant invention except for the semiconductor die coated with at least one of titanium, tungsten, gold or a combination thereof for soldering. However, Takekawa discloses that a semiconductor die can be coated with gold to stabilize the potential to be produced at the lower surface of the substrate (col. 10/lls. 52-57). It would have been obvious to one of ordinary skill in the art at the time the invention was made to coat the bottom surface of the semiconductor die disclosed by Tsuji in view of Morifudi with gold in order to stabilize the potential to be produced at the lower surface of the substrate as taught by Takekawa.

Allowable Subject Matter

7. Claims 12 and 15 are allowed.

8. Claims 13 and 14 objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Response to Arguments

9. Applicant's arguments with respect to pending claims have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

10. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Ref 6,249,046 shows embodiments similar to the instant invention.
- 11.
12. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Leonardo Andújar whose telephone number is 571-272-1912. The examiner can normally be reached on Mon through Thu from 9:00 AM to 7:30 PM EST.
13. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Sue Purvis can be reached on 571-272-1236. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.
14. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.



Leonardo Andújar

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Primary Examiner
Art Unit 2826

01/18/2008